## SQD50N03-06P

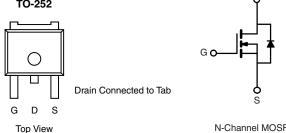


**Vishay Siliconix** 

# Automotive N-Channel 30 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	30				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 V$	0.0060				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 V$	0.0085				
I <sub>D</sub> (A)	50				
Configuration	Single				

#### TO-252



### **FEATURES**

- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>q</sub> and UIS Tested
- AEC-Q101 Qualified
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



N-Channel MOSFET

D

ORDERING INFORMATION	
Package	TO-252
Lead (Pb)-free and Halogen-free	SQD50N03-06P-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unles	s otherwise noted	)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> = 25 °C	1	50		
	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	50		
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	50	А	
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	200		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	45		
Single Pulse Avalanche Energy	L = 0.1 MH	E <sub>AS</sub>	101	mJ	
Maximum Power Dissipation <sup>b</sup>	T <sub>C</sub> = 25 °C	D	83	W	
	T <sub>C</sub> = 125 °C	- P <sub>D</sub>	27	vv	
Operating Junction and Storage Temperature Range	ge	T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-Ambient	PCB Mount <sup>c</sup>	R <sub>thJA</sub>	50	°C/W
Junction-to-Case (Drain)		R <sub>thJC</sub>	1.8	C/W

#### Notes

a. Package limited.

b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

c. When mounted on 1" square PCB (FR-4 material).

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## SQD50N03-06P



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$		30	-	-	N
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	1.5	2.0	2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =	0 V, $V_{GS} = \pm 20$ V	-	-	± 100	nA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 30 V	-	-	1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V$	V <sub>DS</sub> = 30 V, T <sub>J</sub> = 125 °C	-	-	50	μA
		$V_{GS} = 0 V$	V <sub>DS</sub> = 30 V, T <sub>J</sub> = 175 °C	-	-	250	1
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A	-	0.0047	0.0060	Ω
Drain Source On State Resistence?	Р	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C	-	-	0.0090	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C	-	-	0.0107	
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 20 A	-	0.0067	0.0085	
Forward Transconductanceb	9 <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 20 A	-	74	-	S
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>		<sub>GS</sub> = 0 V V <sub>DS</sub> = 25 V, f = 1 MHz	-	3222	4030	pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 V$		-	563	705	
Reverse Transfer Capacitance	C <sub>rss</sub>	]		-	241	300	
Total Gate Charge <sup>c</sup>	Qg			-	25.2	38	
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{GS} = 4.5 V$	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 50 \text{ A}$	-	9.1	-	nC
Gate-Drain Charge <sup>c</sup>	Q <sub>gd</sub>	]		-	9.4	-	
Gate Resistance	Rg	f = 1 MHz		0.5	1.6	2.8	Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			-	10	15	
Rise Time <sup>c</sup>	t <sub>r</sub>	$\label{eq:V_DD} \begin{array}{l} V_{\text{DD}} = 15 \text{ V}, \ R_{\text{L}} = 0.3 \ \Omega \\ I_{\text{D}} \cong 50 \text{ A}, \ V_{\text{GEN}} = 10 \text{ V}, \ R_{g} = 1 \ \Omega \end{array}$		-	10	15	ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			-	26	39	
Fall Time <sup>c</sup>	t <sub>f</sub>			-	9	14	
Source-Drain Diode Ratings and Char	acteristics <sup>b</sup>				·		
Pulsed Current <sup>a</sup>	I <sub>SM</sub>			-	-	200	Α
Forward Voltage	V <sub>SD</sub>	I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V		-	1	1.5	V

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

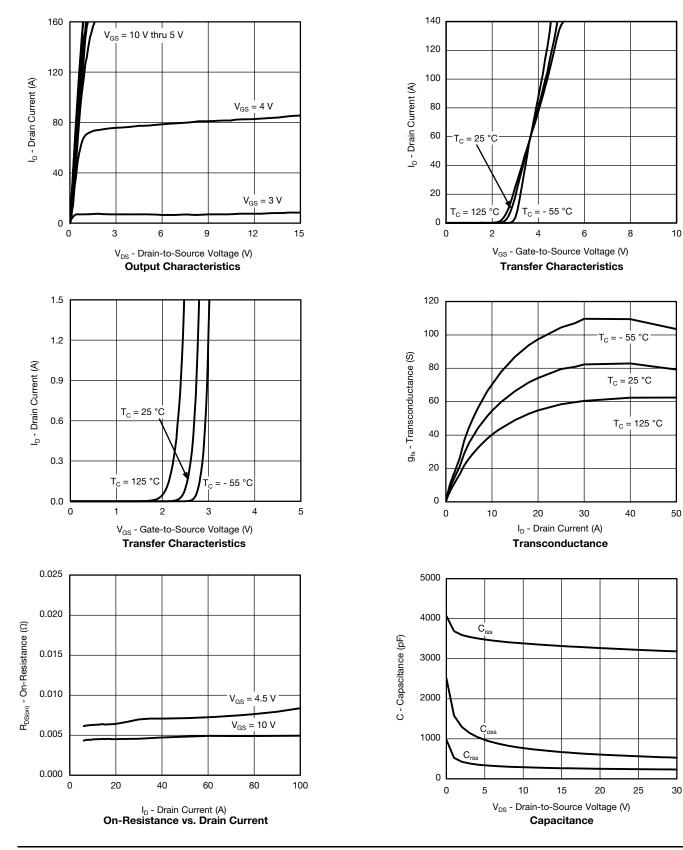
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# SQD50N03-06P

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## **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



S12-2198-Rev. E, 24-Sep-12

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= 50 A

I<sub>D</sub>

10

8

6

4

2

0

0

10

20

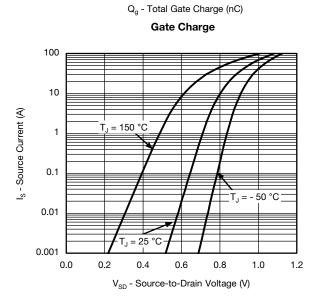
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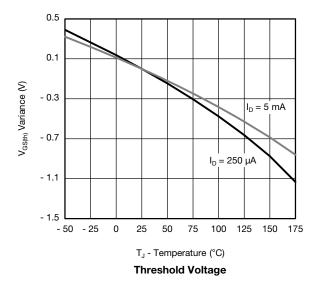
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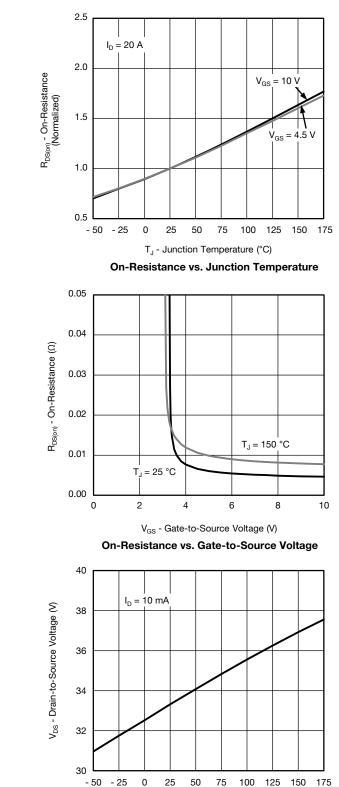
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V<sub>GS</sub> - Gate-to-Source Voltage (V)



Source Drain Diode Forward Voltage





T<sub>J</sub> - Junction Temperature (°C) Drain Source Breakdown vs. Junction Temperature

SQD50N03-06P Vishay Siliconix

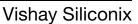
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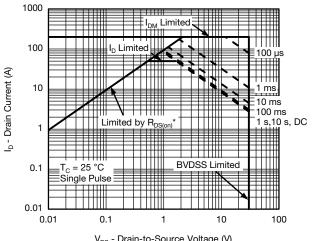
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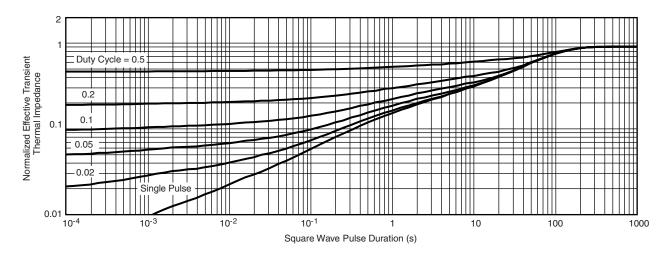




### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



 $\label{eq:V_S} \begin{array}{l} V_{DS} \mbox{-} Drain-to-Source Voltage (V) \\ * \, V_{GS} \mbox{-} minimum \, V_{GS} \mbox{ at which } R_{DS(on)} \mbox{ is specified} \\ \hline { { Safe Operating Area} } \end{array}$ 

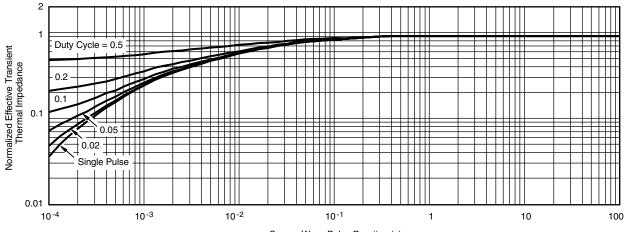


Normalized Thermal Transient Impedance, Junction-to-Ambient



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### **THERMAL RATINGS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



Square Wave Pulse Duration (s)

#### Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

The characteristics shown in the two graphs

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

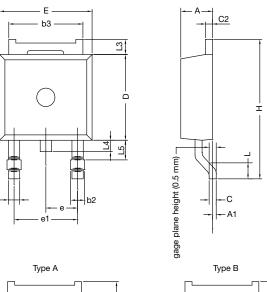
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

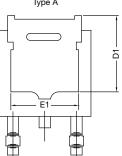
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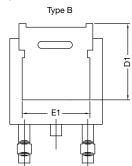


TO-252AA Case Outline





b



DIM.	MILLIN	<b>METERS</b>	INCHES	
	MIN.	MAX.	MIN.	MAX.
А	2.18	2.38	0.086	0.094
A1	-	0.127	-	0.005
b	0.64	0.88	0.025	0.035
b2	0.76	1.14	0.030	0.045
b3	4.95	5.46	0.195	0.215
С	0.46	0.61	0.018	0.024
C2	0.46	0.89	0.018	0.035
D	5.97	6.22	0.235	0.245
D1	4.10	-	0.161	-
E	6.35	6.73	0.250	0.265
E1	4.32	-	0.170	-
Н	9.40	10.41	0.370	0.410
е	2.28 BSC		0.090 BSC	
e1	4.56 BSC		0.180 BSC	
L	1.40	1.78	0.055	0.070
L3	0.89	1.27	0.035	0.050
L4	-	1.02	-	0.040
L5	1.01	1.52	0.040	0.060

#### Notes

• Dimension L3 is for reference only

• Dimension D1 and E1 on type A and B is the same

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### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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